# XN06114 (XN6114)

## Silicon PNP epitaxial planer transistor

## For switching/digital circuits

#### Features

- Two elements incorporated into one package. (Transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half.

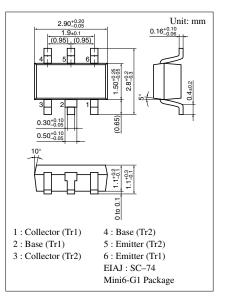
## Basic Part Number of Element

• UNR1114(UN1114)  $\times$  2 elements

Parameter		Symbol	Ratings	Unit	
Rating of element	Collector to base voltage	V <sub>CBO</sub>	-50	V	
	Collector to emitter voltage	V <sub>CEO</sub>	-50	V	
	Collector current	I <sub>C</sub>	-100	mA	
Overall	Total power dissipation	P <sub>T</sub>	300	mW	
	Junction temperature	Tj	150	°C	
	Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

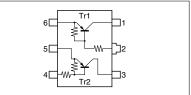
#### Absolute Maximum Ratings (Ta=25°C)

Electrical Characteristics (Ta=25°C)



### Marking Symbol: CK

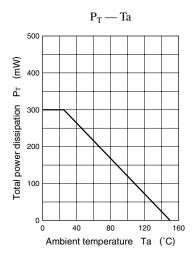
#### Internal Connection

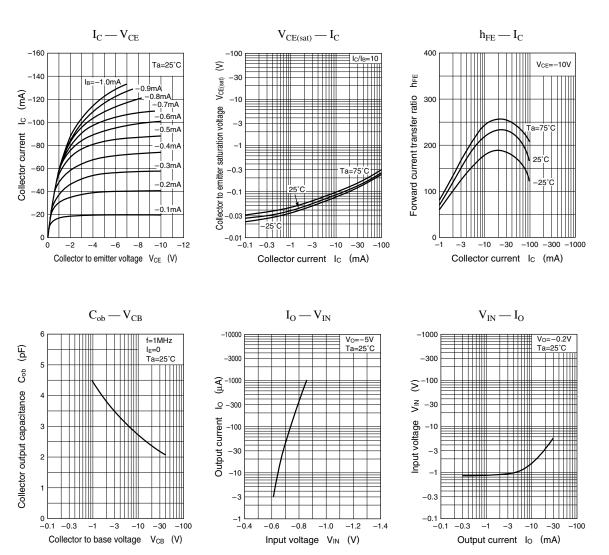


Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	$I_{\rm C} = -10 \mu A, I_{\rm E} = 0$	-50			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_{\rm C} = -2mA, I_{\rm B} = 0$	-50			V
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = -50V, I_E = 0$			- 0.1	μΑ
Conector cuton current	I <sub>CEO</sub>	$V_{CE} = -50V, I_B = 0$			- 0.5	μΑ
Emitter cutoff current	I <sub>EBO</sub>	$V_{EB} = -6V, I_C = 0$			- 0.2	mA
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = -10V, I_C = -5mA$	80			
Forward current transfer h <sub>FE</sub> ratio	h <sub>FE</sub> (small/large)*1	$V_{CE} = -10V, I_C = -5mA$	0.5	0.99		
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = -0.3 {\rm mA}$			- 0.25	V
Output voltage high level	V <sub>OH</sub>	$V_{CC} = -5V, V_B = -0.5V, R_L = 1k\Omega$	-4.9			V
Output voltage low level	V <sub>OL</sub>	$V_{CC} = -5V, V_B = -2.5V, R_L = 1k\Omega$			- 0.2	V
Transition frequency	f <sub>T</sub>	$V_{CB} = -10V, I_E = 1mA, f = 200MHz$		80		MHz
Input resistance	R <sub>1</sub>		-30%	10	+30%	kΩ
Resistance ratio	R <sub>1</sub> /R <sub>2</sub>		0.17	0.21	0.25	

\*1 Ratio between 2 elements

Note) The Part number in the Parenthesis shows conventional part number.





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